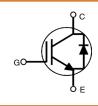
onsemi

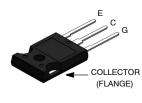
DATA SHEET

www.onsemi.com

IGBT - Field Stop, Trench 650 V, 40 A FGH40T65SQD

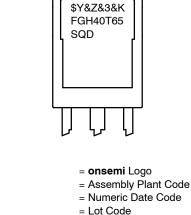
| V _{CES} | Ι _C |
|------------------|----------------|
| 650 V | 40 A |





TO-247-3LD CASE 340CH

MARKING DIAGRAM



&K = Lot Code FGH40T65SQD = Specific Device Code

\$Y

&Z

&З

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Description

Using novel field stop IGBT technology, **onsemi**'s new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Max Junction Temperature 175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.6 \text{ V} (Typ.) @ I_C = 40 \text{ A}$
- 100% of the Parts Tested for I_{LM}
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC

ABSOLUTE MAXIMUM RATINGS

| Symbol | Description | | FGH40T65SQD-F155 | Unit |
|--------------------------|--|------------------------------|------------------|------|
| V _{CES} | Collector to Emitter Voltage | | 650 | V |
| V _{GES} | Gate to Emitter Voltage | | ±20 | V |
| | Transient Gate to Emitter Voltage | | ±30 | V |
| Ι _C | Collector Current | T _C = 25°C | 80 | А |
| | [[| T _C = 100°C | 40 | А |
| I _{LM} (Note 1) | Pulsed Collector Current | T _C = 25°C | 160 | А |
| I _{CM} (Note 2) | Pulsed Collector Current | ulsed Collector Current | | А |
| ١ _F | Diode Forward Current | T _C = 25°C | 40 | А |
| | Diode Forward Current | T _C = 100°C | 20 | А |
| I _{FM} (Note 2) | Pulsed Diode Maximum Forward Current | | 160 | А |
| PD | Maximum Power Dissipation | T _C = 25°C | 238 | W |
| | [[| T _C = 100°C | 119 | W |
| TJ | Operating Junction Temperature | | –55 to +175 | °C |
| T _{STG} | Storage Temperature Range | | –55 to +175 | °C |
| ΤL | Maximum Lead Temp. for Soldering Purposes, | 1/8" from Case for 5 Seconds | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. $V_{CC} = 400 \text{ V}$, $V_{GE} = 15 \text{ V}$, $I_C = 160 \text{ A}$, $R_G = 22 \Omega$, Inductive Load. 2. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

| Symbol | Parameter | FGH40T65SQD-F155 | Unit |
|-------------------------|---|------------------|------|
| R _{θJC} (IGBT) | Thermal Resistance, Junction to Case, Max. | 0.63 | °C/W |
| $R_{\theta JC}$ (Diode) | Thermal Resistance, Junction to Case, Max. | 1.71 | °C/W |
| $R_{	hetaJA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | °C/W |

PACKAGE MARKING AND ORDERING INFORMATION

| Device Marking | Device | Package | Reel Size | Tape Width | Qty per Tube |
|----------------|------------------|------------|-----------|------------|--------------|
| FGH40T65SQD | FGH40T65SQD-F155 | TO-247-3LD | I | - | 30 |

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|--|--|--|-----|------|------|------|
| OFF CHARACT | ERISTICS | | | | 1 | |
| BV _{CES} | Collector to Emitter Breakdown Voltage | V _{GE} = 0 V, I _C = 1 mA | 650 | - | - | V |
| $\Delta \text{BV}_{\text{CES}} / \Delta \text{T}_{\text{J}}$ | Temperature Coefficient of Breakdown Voltage | V _{GE} = 0 V, I _C = 1 mA | - | 0.6 | - | V/°C |
| I _{CES} | Collector Cut-Off Current | $V_{CE} = V_{CES}, V_{GE} = 0 V$ | - | - | 250 | μΑ |
| I _{GES} | G-E Leakage Current | $V_{GE} = V_{GES}, V_{CE} = 0 V$ | - | - | ±400 | nA |
| ON CHARACTE | RISTICS | | | | 1 | • |
| V _{GE(th)} | G-E Threshold Voltage | I_{C} = 40 mA, V_{CE} = V_{GE} | 2.6 | 4.5 | 6.4 | V |
| V _{CE(sat)} | Collector to Emitter Saturation Voltage | I _C = 40 A, V _{GE} = 15 V | - | 1.6 | 2.1 | V |
| | | I _C = 40 A, V _{GE} = 15 V, T _C = 175°C | _ | 1.92 | _ | v |
| DYNAMIC CHA | RACTERISTICS | | | | 1 | • |
| Cies | Input Capacitance | V _{CE} = 30 V, V _{GE} = 0 V, | - | 2620 | - | pF |
| C _{oes} | Output Capacitance | f = 1MHz | _ | 60 | _ | pF |
| C _{res} | Reverse Transfer Capacitance | 1 | - | 9 | - | pF |
| SWITCHING CH | IARACTERISTICS | | | | 1 | • |
| T _{d(on)} | Turn-On Delay Time | V _{CC} = 400 V, I _C = 10 A, | - | 16.4 | - | ns |
| T _r | Rise Time | $R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$ | - | 4.8 | _ | ns |
| T _{d(off)} | Turn-Off Delay Time | _ | - | 86.4 | - | ns |
| Τ _f | Fall Time | | - | 8.8 | - | ns |
| Eon | Turn–On Switching Loss | | - | 138 | - | μJ |
| E _{off} | Turn–Off Switching Loss | | - | 52 | _ | μJ |
| E _{ts} | Total Switching Loss | | - | 190 | - | μJ |
| T _{d(on)} | Turn–On Delay Time | $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A},$ | - | 17.6 | _ | ns |
| Tr | Rise Time | $R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$ | - | 9.6 | _ | ns |
| T _{d(off)} | Turn-Off Delay Time | | - | 80 | - | ns |
| Τ _f | Fall Time | | - | 8.8 | - | ns |
| Eon | Turn–On Switching Loss | | - | 329 | - | μJ |
| E _{off} | Turn–Off Switching Loss | | - | 84 | _ | μJ |
| E _{ts} | Total Switching Loss | | - | 413 | - | μJ |
| T _{d(on)} | Turn–On Delay Time | V _{CC} = 400 V, I _C = 10 A, R _G = 6 Ω, V _{GE} = 15 V, | - | 14.4 | - | ns |
| T _r | Rise Time | Inductive Load, $T_C = 175^{\circ}C$ | - | 6.4 | - | ns |
| T _{d(off)} | Turn–Off Delay Time | 1 | - | 99.2 | - | ns |
| Т _f | Fall Time |] | - | 8 | - | ns |
| Eon | Turn-On Switching Loss | 1 | - | 269 | - | μJ |
| E _{off} | Turn–Off Switching Loss | 1 | - | 132 | - | μJ |
| E _{ts} | Total Switching Loss | 1 | | 401 | _ | μJ |

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit | | | |
|---------------------|--------------------------|--|-----|------|-----|------|--|--|--|
| SWITCHING C | WITCHING CHARACTERISTICS | | | | | | | | |
| T _{d(on)} | Turn-On Delay Time | V _{CC} = 400 V, I _C = 20 A, R _G = 6 Ω, V _{GE} = 15 V, | - | 16 | - | ns | | | |
| Tr | Rise Time | Inductive Load, $T_C = 175^{\circ}C$ | - | 11.2 | - | ns | | | |
| T _{d(off)} | Turn-Off Delay Time | | - | 91.2 | - | ns | | | |
| T _f | Fall Time | | - | 8 | - | ns | | | |
| E _{on} | Turn–On Switching Loss | | - | 581 | - | μJ | | | |
| E _{off} | Turn–Off Switching Loss | | - | 237 | - | μJ | | | |
| E _{ts} | Total Switching Loss | | - | 818 | - | μJ | | | |
| Qg | Total Gate Charge | V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V | - | 80 | - | nC | | | |
| Q _{ge} | Gate to Emitter Charge | VGE = 15 V | - | 15 | - | nC | | | |
| Q _{gc} | Gate to Collector Charge | | - | 20 | - | nC | | | |

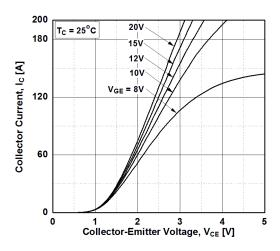
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25° C unless otherwise noted)

| Symbol | Parameter | Test Conditions | | Min | Тур | Max | Unit |
|------------------|-------------------------------|--|---------------------------------|-----|------|-----|------|
| V _{FM} | Diode Forward Voltage | I _F = 20 A | $T_C = 25^{\circ}C$ | - | 2.2 | 2.8 | V |
| | | | T _C = 175°C | - | 1.94 | - | |
| E _{rec} | Reverse Recovery Energy | I _F = 20 A, dI _F /dt = 200 A/μs | T _C = 175°C | - | 50 | - | μJ |
| T _{rr} | Diode Reverse Recovery Time | αι _F /αι = 200 Α/μ3 | $T_{C} = 25^{\circ}C$ | - | 31.8 | - | ns |
| | | | T _C = 175°C | - | 192 | - | |
| Q _{rr} | Diode Reverse Recovery Charge | 1 | $T_{\rm C} = 25^{\circ}{\rm C}$ | - | 50.6 | - | nC |
| | | | T _C = 175°C | - | 699 | - | 1 |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





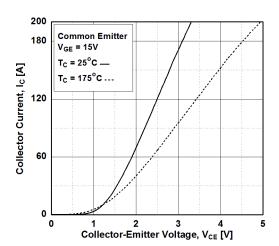


Figure 3. Typical Saturation Voltage Characteristics

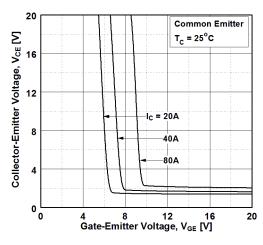


Figure 5. Saturation Voltage vs. V_{GE}

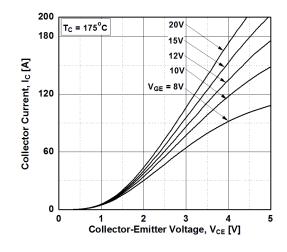


Figure 2. Typical Output Characteristics

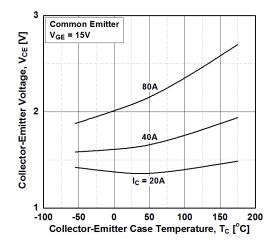


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

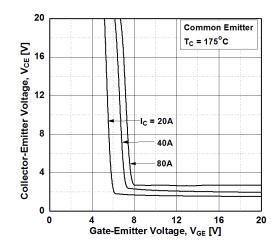


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL CHARACTERISTICS (Continued)

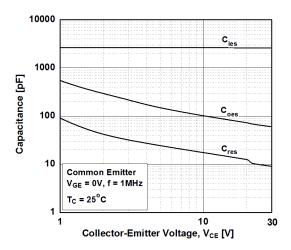
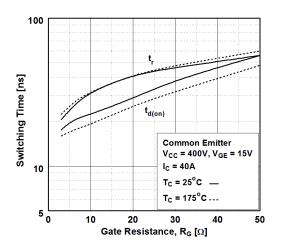
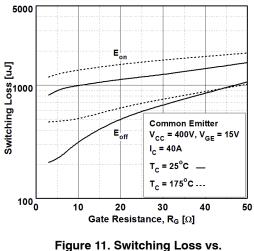


Figure 7. Capacitance Characteristics







gure 11. Switching Loss ve Gate Resistance

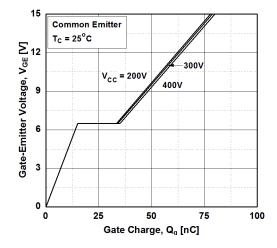


Figure 8. Gate Charge Characteristics

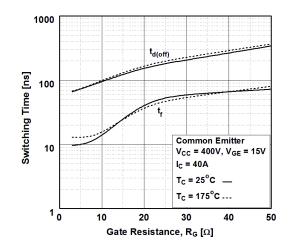
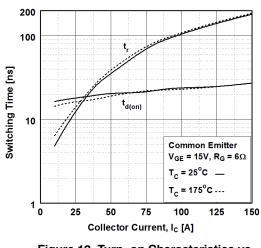
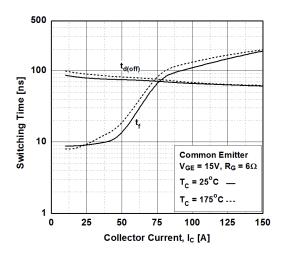


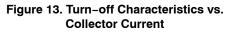
Figure 10. Turn-off Characteristics vs. Gate Resistance





TYPICAL CHARACTERISTICS (Continued)





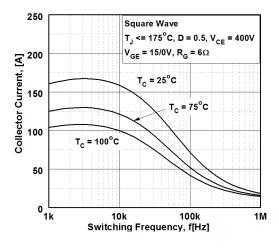


Figure 15. Load Current vs. Frequency

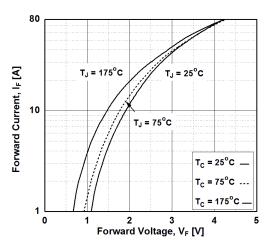
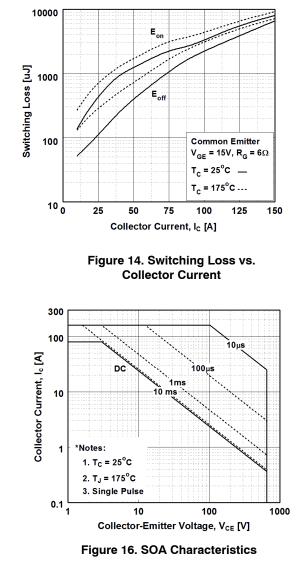


Figure 17. Forward Characteristics



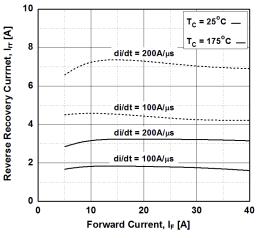


Figure 18. Reverse Recovery Current

TYPICAL CHARACTERISTICS (Continued)

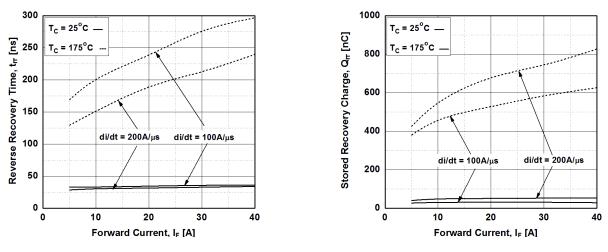


Figure 19. Reverse Recovery Time

Figure 20. Stored Charge

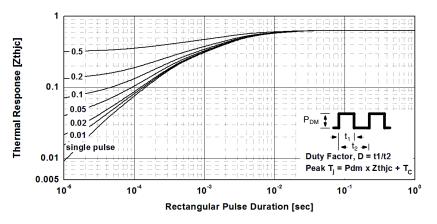


Figure 21. Transient Thermal Impedance of IGBT

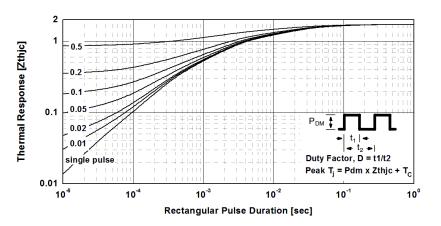
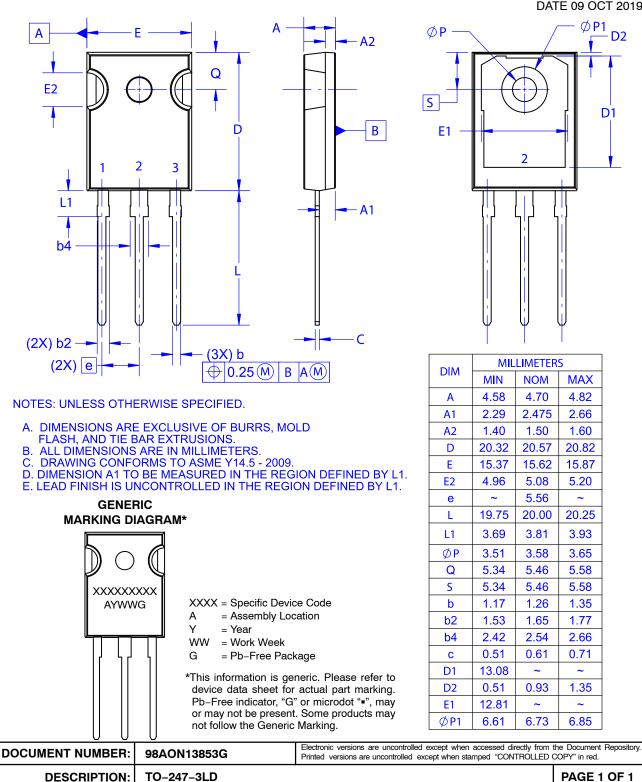


Figure 22. Transient Thermal Impedance of Diode



TO-247-3LD CASE 340CH **ISSUE A**

DATE 09 OCT 2019



onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>